

DESCRIPTION

The IS181 series of optocoupler consists of an infrared light emitting diode optically coupled to an NPN silicon photo transistor in a space efficient Mini Flat Package.

FEATURES

- Low Profile Package
- AC Isolation Voltage 3750V_{RMS}
- CTR Selections Available
- Wide Operating Temperature Range -55°C to +110°C
- Lead Free and RoHS Compliant
- UL File E91231 model "FPT1" and "FPT2"

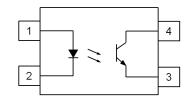
APPLICATIONS

- Computer Terminals
- Industrial System Controllers
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedance

ORDER INFORMATION

 Available in Tape and Reel with 3000 pieces per reel





- Anode
- 2 Cathode
- 3 Emitter
- 4 Collector

ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

Forward Current	50mA
Reverse Voltage	6V
Power dissipation	70mW

Output

Collector to Emitter Voltage BV _{CEO}	80V
Emitter to Collector Voltage BV_{ECO}	6V
Collector Current	50mA
Power Dissipation	150mW

Total Package

Isolation Voltage	$3750V_{\text{RMS}}$
Total Power Dissipation	170mW
Operating Temperature	-55 to 110 °C
Storage Temperature	-55 to 150 °C
Lead Soldering Temperature (10s)	260°C

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

INPUT

Parameter	Symbol	mbol Test Condition		Тур.	Max	Unit
Forward Voltage	V_{F}	$I_F = 20 \text{mA}$		1.2	1.4	V
Reverse Current	I_R	$V_R = 4V$			10	μΑ
Terminal Capacitance	C_{t}	V = 0V, $f = 1KHz$		30	250	pF

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector-Emitter Breakdown Voltage	$\mathrm{BV}_{\mathrm{CEO}}$	$I_C = 0.1 \text{mA}, I_F = 0 \text{ mA}$	80			V
Emitter-Collector Breakdown Voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_E = 10\mu A, I_F = 0mA$	6			V
Collector-Emitter Dark Current	I_{CEO}	$V_{CE} = 20V$, $I_F = 0mA$			100	nA

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current Transfer Ratio	CTR	$I_F = 5 \text{mA}, V_{CE} = 5 \text{V}$	50		600	%
		Optional CTR Grades IS181A IS181B IS181C IS181D IS181GR IS181GB	80 130 200 300 100 100		160 260 400 600 300 600	
Collector-Emitter Saturation Voltage	$V_{\text{CE(sat)}}$	$I_F = 20 \text{mA}, I_C = 1 \text{mA}$			0.2	V
Floating Capacitance	C_{f}	V = 0V, $f = 1MHz$		0.6	1	pF
Output Rise Time	$t_{\rm r}$	$V_{CE} = 2V$, $Ic = 2mA$, $R_{L} = 100\Omega$	_	4	18	μs
Output Fall Time	t_{f}	$V_{CE} = 2V$, $Ic = 2mA$, $R_L = 100\Omega$		3	18	μs

ISOLATION

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Insulation Voltage	$V_{\rm ISO}$	RH = 40% to 60%, $t = 1$ min,	3750			V
Input - Output Resistance	R _{I-O}	$V_{I-O} = 500 VDC$	5x10 ¹⁰			Ω



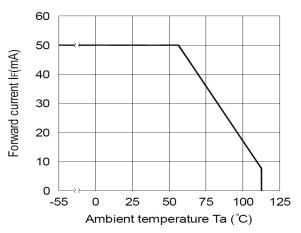


Fig 1 Forward Current vs TA

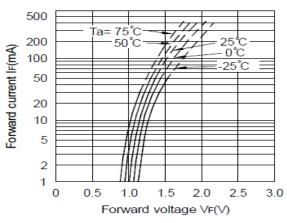


Fig 3 Forward Current vs Forward Voltage

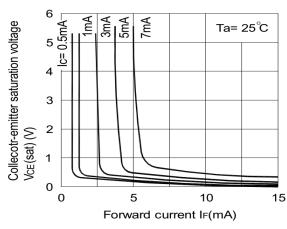


Fig 5 Collector-Emitter Saturation Voltage vs Forward Current

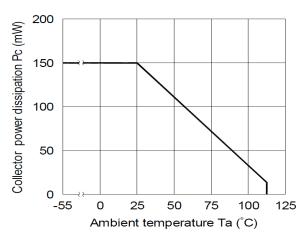


Fig 2 Collector Power Dissipation vs TA

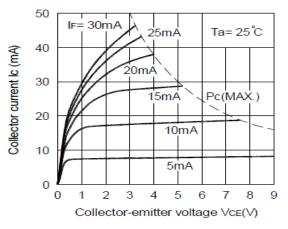


Fig 4 Collector Current vs Collector-Emitter Voltage

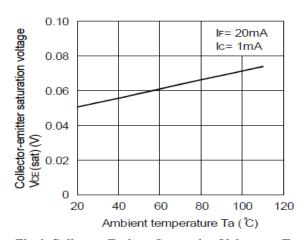


Fig 6 Collector-Emitter Saturation Voltage vs T_A



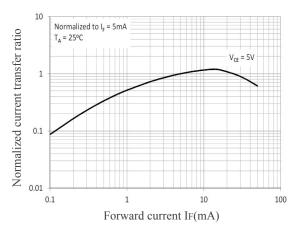


Fig 7 Normalized Current Transfer Ratio vs Forward Current

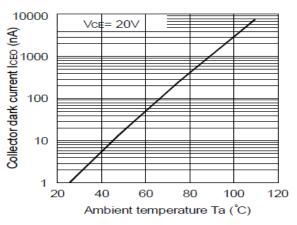


Fig 9 Collector Dark Current vs T_A

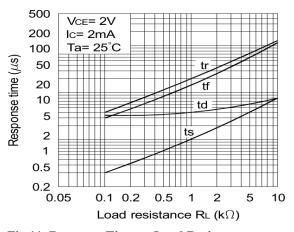


Fig 11 Response Time vs Load Resistance

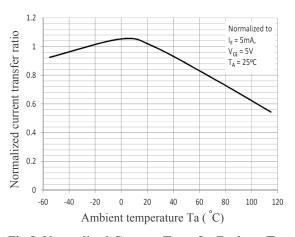


Fig 8 Normalized Current Transfer Ratio vs $T_{\rm A}$

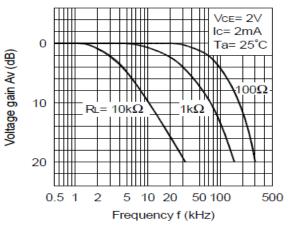
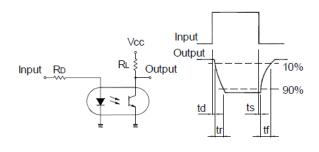


Fig 10 Frequency response



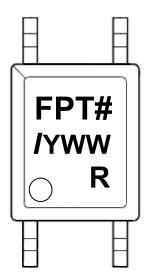


ORDER INFORMATION

IS181					
After PN	PN	Description	Packing quantity		
None	IS181	Surface Mount Tape & Reel	3000 pcs per reel		
Any CTR Grade	IS181A, IS181B, IS181C, IS181D, IS181GR, IS181GB	Surface Mount Tape & Reel	3000 pcs per reel		

NOTE: Multiple Grades may be supplied to meet the requested specification.

DEVICE MARKING



FPT# denotes Device Part Number where "#" is internal control number

which can be "1" or '2"

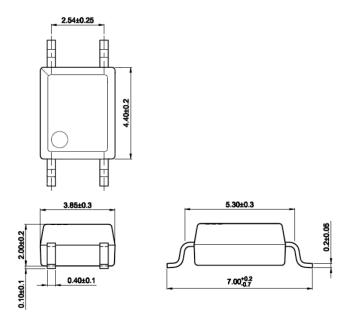
I denotes Isocom

Y denotes 1 digit Year code WW denotes 2 digit Week code

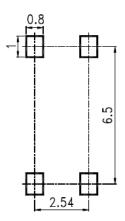
R denotes CTR Grade



PACKAGE DIMENSIONS (mm)

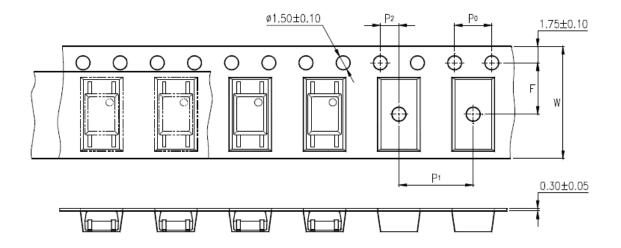


RECOMMENDED SOLDER PAD LAYOUT (mm)





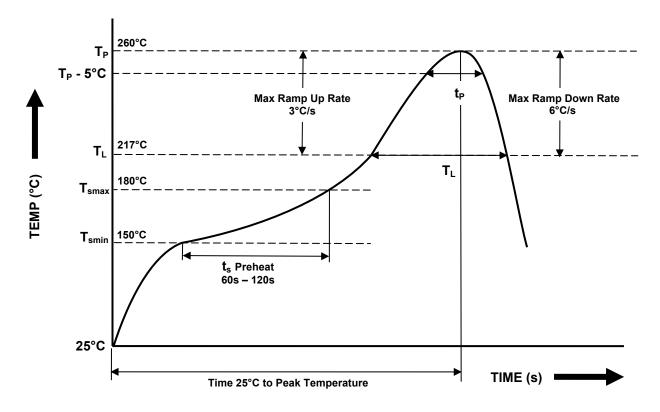
TAPE AND REEL PACKAGING



Description	Symbol	Dimension mm (inch)
Tape Width	W	12 ± 0.3 (0.47)
Pitch of Sprocket Holes	P ₀	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	5.5 ± 0.1 (0.217)
Distance of Compartment to Sprocket Holes	P ₂	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P ₁	8 ± 0.1 (0.315)



IR REFLOW SOLDERING TEMPERATURE PROFILE One Time Reflow Soldering is Recommended. Do not immerse device body in solder paste.



Profile Details	Conditions
Preheat - Min Temperature (T _{SMIN}) - Max Temperature (T _{SMAX}) - Time T _{SMIN} to T _{SMAX} (t _s)	150°C 180°C 60s - 120s
$ \begin{array}{l} \textbf{Soldering Zone} \\ - \text{ Peak Temperature } (T_P) \\ - \text{ Liquidous Temperature } (T_L) \\ - \text{ Time within 5°C of Actual Peak Temperature } (T_P - 5°C) \\ - \text{ Time maintained above } T_L \ (t_L) \\ - \text{ Ramp Up Rate } (T_L \text{ to } T_P) \\ - \text{ Ramp Down Rate } (T_P \text{ to } T_L) \\ \end{array} $	260°C 217°C 20s 60s 3°C/s max 3 - 6°C/s
Average Ramp Up Rate (T _{smax} to T _P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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